

## Improved thermoelectric performance of *p*-type Si-Ge alloy

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### Introduction

In order to improve the figure of merit  $ZT$ , many strategies have been reported. For example, nano-structuring and modulation doping approach has been utilized to improve the thermoelectric properties of Si-Ge alloy by decreasing thermal conductivity without degrading the power factor [1].

Our previous studies revealed that B-doped Si-Ge-Au thin film and bulk sample possessed  $ZT$  value of 1.38 and 1.63 at 1000K. We found that the electron transport properties were constructively improved using Au-doping to form an impurity level near the valence band top, and B-doping to control the Fermi level. Very small thermal conductivity  $\sim 1.5 \text{ Wm}^{-1}\text{K}^{-1}$  was obtained due to nanograins. However, Au is an expensive element and more than  $ZT = 1.63$  is required for improving efficiency. In the present study, we synthesized bulk noncrystalline B-doped Si-Ge alloy with other metal substitution, which is a cheap and non-toxic element. Thermoelectric properties of bulk nanocrystalline samples were investigated as a function of temperature 300 – 1000 K, respectively.

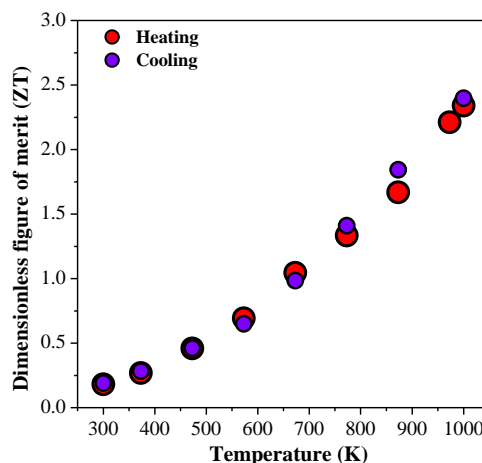
### Experimental Procedure

High purity metal substituted Ge mother ingot was crushed into powders and sealed with the high purity Si (5N) and 3 at.% of boron in a Zirconia container with Zirconia balls in the glove box under pressurized Ar gas atmosphere. The mixed powders were milled at a speed of 600 rpm for 6 h. Afterwards, the powders were subsequently sintered with a relatively high pressure of 400 MPa at 973 K for 4 h.

### Results and discussion

The powder XRD indicated that the single

phase of diamond structure was obtained after the ball-milling. The size of nano-crystals in the bulk sample was estimated to be 30 nm from the XRD peaks and the Scherrer equation. The large Seebeck coefficient of  $366 \mu\text{V}^{-1}\text{K}^{-1}$  at 1000 K was obtained presumably due to presence of sharp peaks near the valence band edge. The electrical resistivity was  $3.78 \text{ m}\Omega\text{cm}$  at 1000 K. As a consequence, a very large power factor reaching  $3.54 \text{ mWm}^{-1}\text{K}^{-2}$  together with low thermal conductivity  $1.49 \text{ Wm}^{-1}\text{K}^{-1}$  allow us to obtain high  $ZT = 2.4$  at 1000 K, respectively as shown in Fig.1. The obtained  $ZT$  was approximately 50% higher than that of the previously reported Si-Ge-Au nanocomposites ( $ZT = 1.63$ ) [2].



**Figure 1** Figure of merit of B-doped Si-Ge with metal substituted nanocrystalline sample as a function of temperature.

### References

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- [2] M. Omprakash *et al.*, *Jpn. J. Appl. Phys.* **58**, 125501 (2019).